BLL1214-250R

LDMOS L-band radar power transistor

AMPLEON

Rev. 2 — 1 September 2015

Product data sheet

1. Product profile

1.1 General description

Silicon N-channel enhancement model LDMOS power transistor encapsulated in a 2-lead flange package (SOT502A) with a ceramic cap. The common source is connected to the flange.

Table 1. Test information

Typical RF performance at T_h = 25 °C; t_p = 1 ms; δ = 10 %; in a common source class-AB test circuit.

Mode of operation	f	V _{DS}	I _{Dq}	PL	Gp	η_D	P _{droop(pulse)}	t _r	t _f
	(GHz)	(V)	(mA)	(W)	(dB)	(%)	(dB)	(ns)	(ns)
pulsed RF	1.2 to 1.4	36	150	250	13	47	0.2	15	5

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features

- Typical pulsed RF performance at a frequency of 1.2 GHz to 1.4 GHz, a supply voltage of 36 V, an I_{Dq} of 150 mA, a t_D of 1 ms with δ of 10 %:
 - ◆ Output power = 250 W
 - ◆ Power gain = 13 dB
 - ◆ Efficiency = 47 %
- High power gain
- Easy power control
- Excellent ruggedness
- Source on mounting base eliminates DC isolators, reducing common mode inductance.

1.3 Applications

■ L-band radar applications in the 1.2 GHz to 1.4 GHz frequency range

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	drain		,
2	gate		1
3	source		2 — 3 sym112

^[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package			
	Name	Description	Version	
BLL1214-250R	-	flanged LDMOST ceramic package; 2 mounting holes; 2 leads	SOT502A	

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	75	V
V_{GS}	gate-source voltage		-22	+22	V
P _{tot}	total power dissipation	$T_h \le 70$ °C; t_p = 1 ms; δ = 10 %	-	400	Α
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	200	°C

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$Z_{\text{th(j-h)}}$ transient thermal impedance from junction to heatsink	T _h = 25 °C			
	t_p = 100 μ s; δ = 10 %	0.17	K/W	
		$t_p = 1 \text{ ms}; \delta = 10 \%$	0.32	K/W

6. Characteristics

Table 6. DC characteristics

 $T_i = 25 \, ^{\circ}\text{C}$.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{(BR)DSS}	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 3 \text{ mA}$	75	-	-	V
V _{GS(th)}	gate-source threshold voltage	V_{DS} = 10 V; I_{D} = 300 mA	4	-	5	V
I _{DSS}	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 36 \text{ V}$	-	-	1	μΑ
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 9 V;$ $V_{DS} = 10 V$	45	-	-	Α
I _{GSS}	gate leakage current	$V_{GS} = \pm 20 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	1	μΑ
9fs	forward transconductance	V_{DS} = 10 V; I_{D} = 10 A	-	9	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = 9 \text{ V}; I_D = 10 \text{ A}$	-	60	-	$m\Omega$

Table 7. RF characteristics

Mode of operation: pulsed RF; t_p = 1 ms; δ = 10 %; f = 1.2 GHz to 1.4 GHz; RF performance at V_{DS} = 36 V; I_{Dq} = 150 mA; T_h = 25 °C; $Z_{th(mb-h)}$ = 0.25 K/W; unless otherwise specified, in a common source class-AB circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P_L	output power		-	250	-	W
V_{DS}	drain-source voltage	$P_{L} = 250 \text{ W}$	-	36	-	V
Gp	power gain	$P_{L} = 250 \text{ W}$	-	13	-	dB
η_{D}	drain efficiency	$P_{L} = 250 \text{ W}$	-	47	-	%
P _{droop(pulse)}	pulse droop power	$P_{L} = 250 \text{ W}$	-	0.2	-	dB
t _r	rise time	$P_{L} = 250 \text{ W}$	-	15	-	ns
t _f	fall time	$P_{L} = 250 \text{ W}$	-	5	-	ns

6.1 Ruggedness in class-AB operation

The BLL1214-250R is capable of withstanding a load mismatch corresponding to VSWR = 3:1 through all phases under the following conditions: $V_{DS} = 36 \text{ V}$; f = 1.2 GHz to 1.4 GHz at rated load power.

7. Application information

7.1 Impedance information

Table 8. Typical impedance

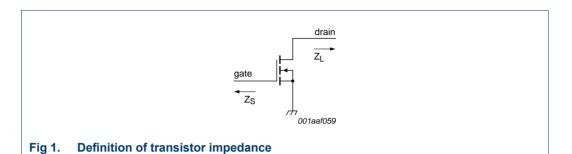
Typical values unless otherwise specified.

f	Z _S	Z L
GHz	Ω	Ω
1.20	1.3 – j2.8	1.1 – j0.9
1.25	1.9 – j2.8	1.0 – j0.5
1.30	4.6 – j2.9	0.8 - j0.2
1.35	5.7 – j0.3	0.7 – j0.3
1.40	2.7 – j1.8	0.6 - j0.4

BLL1214-250R#2

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7.2 Application circuit

Table 9. List of components

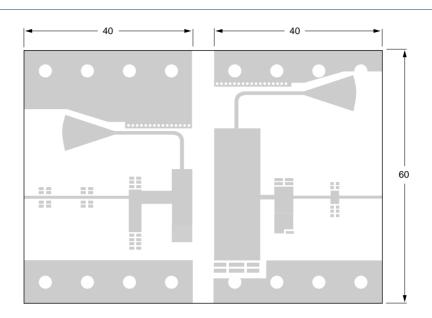
See Figure 2.

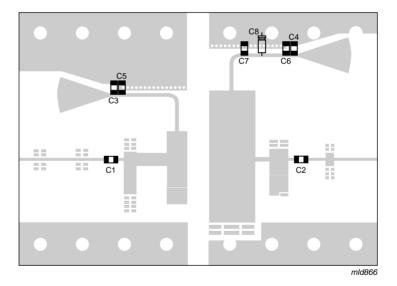
The components are situated in one side of the copper-clad Rodgers Duroid 6010 Printed-Circuit Board (PCB); $\varepsilon_r = 10.2$ F/m; thickness = 0.64 mm. The other side is unetched and serves as a ground plane.

Component	Description	Value	Remarks
C1, C3	multilayer ceramic chip capacitor	39 pF	[1]
C2, C4	multilayer ceramic chip capacitor	47 pF	[1]
C5, C6	multilayer ceramic chip capacitor	20 nF	[2]
C7	multilayer ceramic chip capacitor	36 pF	[2]
C8	electrolytic capacitor	100 μF; 100 V	

^[1] American Technical Ceramics type 100A or capacitor of same quality.

^[2] American Technical Ceramics type 200B or capacitor of same quality.





See $\underline{\text{Table 9}}$ for list of components.

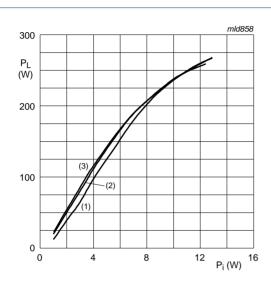
Dimensions in mm.

The components are situated in one side of the copper-clad Rodgers Duroid 6010 Printed-Circuit Board (PCB); ϵ_r = 10.2 F/m; thickness = 0.64 mm. The other side is unetched and serves as a ground plane.

Fig 2. Component layout

8. Test information

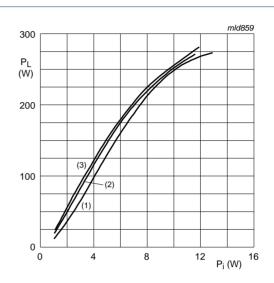
8.1 RF performance



$$t_p$$
 = 1 ms; δ = 10 %.

- (1) f = 1.2 GHz.
- (2) f = 1.3 GHz.
- (3) f = 1.4 GHz.

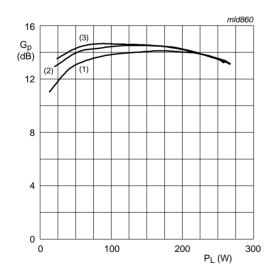
Fig 3. Output power as a function of input power; typical values



$$t_p$$
 = 100 μ s; δ = 10 %.

- (1) f = 1.2 GHz.
- (2) f = 1.3 GHz.
- (3) f = 1.4 GHz.

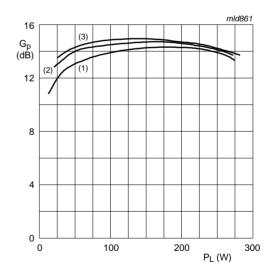
Fig 4. Output power as a function of input power; typical values



 t_p = 1 ms; δ = 10 %.

- (1) f = 1.2 GHz.
- (2) f = 1.3 GHz.
- (3) f = 1.4 GHz.

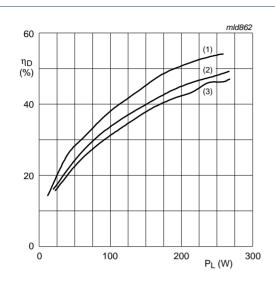
Fig 5. Power gain as a function of load power; typical values



 $t_{\rm p}$ = 100 μ s; δ = 10 %.

- (1) f = 1.2 GHz.
- (2) f = 1.3 GHz.
- (3) f = 1.4 GHz.

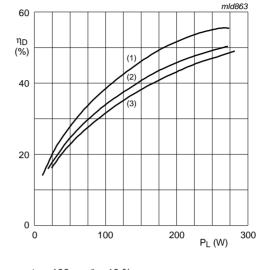
Fig 6. Power gain as a function of load power; typical values



$$t_p$$
 = 1 ms; δ = 10 %.

- (1) f = 1.2 GHz.
- (2) f = 1.3 GHz.
- (3) f = 1.4 GHz.

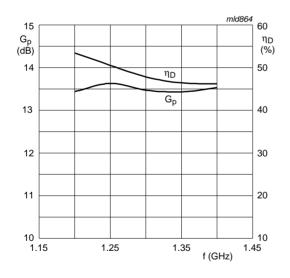
Fig 7. Drain efficiency as a function of load power; typical values



$$t_p$$
 = 100 μ s; δ = 10 %.

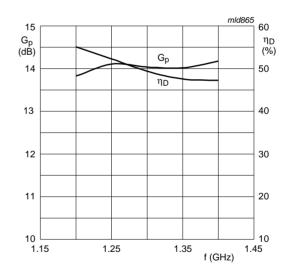
- (1) f = 1.2 GHz.
- (2) f = 1.3 GHz.
- (3) f = 1.4 GHz.

Fig 8. Drain efficiency as a function of load power; typical values



 t_p = 1 ms; δ = 10 %.

Fig 9. Power gain and drain efficiency as function of frequency; typical values



 t_p = 100 μ s; δ = 10 %.

Fig 10. Power gain and drain efficiency as function of frequency; typical values

9. Package outline

Flanged ceramic package; 2 mounting holes; 2 leads

SOT502A

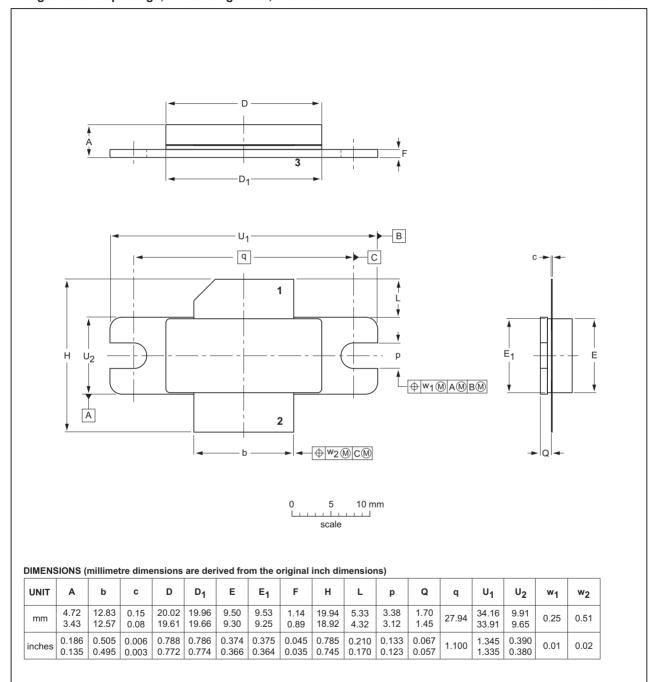


Fig 11. Package outline SOT502A

IEC

OUTLINE

VERSION

SOT502A

JEITA

REFERENCES

JEDEC

ISSUE DATE

-03-01-10

12-05-02

EUROPEAN

PROJECTION

10. Abbreviations

Table 10. Abbreviations

Acronym	Description
DC	Direct Current
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor
RF	Radio Frequency
L-band	Long wave band
VSWR	Voltage Standing-Wave Ratio

11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BLL1214-250R#2	20150901	Product data sheet	-	BLL1214-250R_1	
Modifications:	The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.				
	 Legal texts have 	 Legal texts have been adapted to the new company name where appropriate. 			
BLL1214-250R_1	20100204	Product data sheet	-	-	

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Document status[1][2]	Product status[3]	Definition	
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.	
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.	
Product [short] data sheet	Production	This document contains the product specification.	

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LDMOS L-band radar power transistor

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